



60V N-Channel Trench Power MOSFET

General Description

The SJB2310A uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

Features

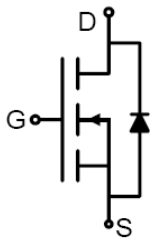
- Low Gate Charge
- High Power and current handling capability
- Lead free product is acquired

Application

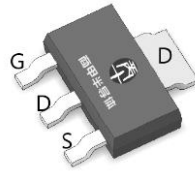
- PWM Applications
- Load Switch
- Power Management

Key Performance Parametes

Parameter	Value	Unit
V_{DS}	60	V
$R_{DS(ON_TYP)}$	64.6	mΩ
I_D	3	A
Q_G	9	nC



Schematic Diagram



SOT-223-3L top view



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJB2310A	SJB2310A	SOT-223-3L	Tape	\	\	3000 Pcs

Table 1. Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0V$)	60	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0V$)	± 20	V
I_D	Drain Current-Continuous($T_A=25^\circ\text{C}$)	3	A
	Drain Current-Continuous($T_A=100^\circ\text{C}$)	1.9	A
I_{DM} (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	12	A
P_D	Maximum Power Dissipation($T_A=25^\circ\text{C}$)	1.7	W
	Maximum Power Dissipation($T_A=100^\circ\text{C}$)	0.7	W
E_{AS}	Avalanche energy (Note 2)	12	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	$^\circ\text{C}$

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		75	$^\circ\text{C/W}$



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Table 3. Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250μA	60			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =60V, V _{GS} =0V T _J =25°C			1	μA
		V _{DS} =60V, V _{GS} =0V T _J =125°C			100	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1		2.5	V
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =2A		4.1		S
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =10V, I _D =2A T _J =25°C		64.6	84	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =4.5V, I _D =1.5A T _J =25°C		78.2	104	mΩ
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =30V,V _{GS} =0V, f=1.0MHz		369		pF
C _{oss}	Output Capacitance			28		pF
C _{rss}	Reverse Transfer Capacitance			22		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		0.78		Ω
Switching Parameters						
t _{d(on)}	Turn-on Delay Time	V _{GS} =10V, V _{DS} =30V, R _L =15Ω, R _{GEN} =3Ω		5		nS
t _r	Turn-on Rise Time			8		nS
t _{d(off)}	Turn-Off Delay Time			36		nS
t _f	Turn-Off Fall Time			21		nS
Q _g	Total Gate Charge	V _{GS} =10V, V _{DS} =30V, I _D =2A		9		nC
Q _{gs}	Gate-Source Charge			1.6		nC
Q _{gd}	Gate-Drain Charge			2		nC
Source-Drain Diode Characteristics						
I _{SD}	Source-Drain Current (Body Diode)				3	A
V _{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =2A			1.2	V
t _{rr}	Reverse Recovery Time	I _F =2A, dI/dt=100A/μs		20		ns
Q _{rr}	Reverse Recovery Charge	I _F =2A, dI/dt=100A/μs		8		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

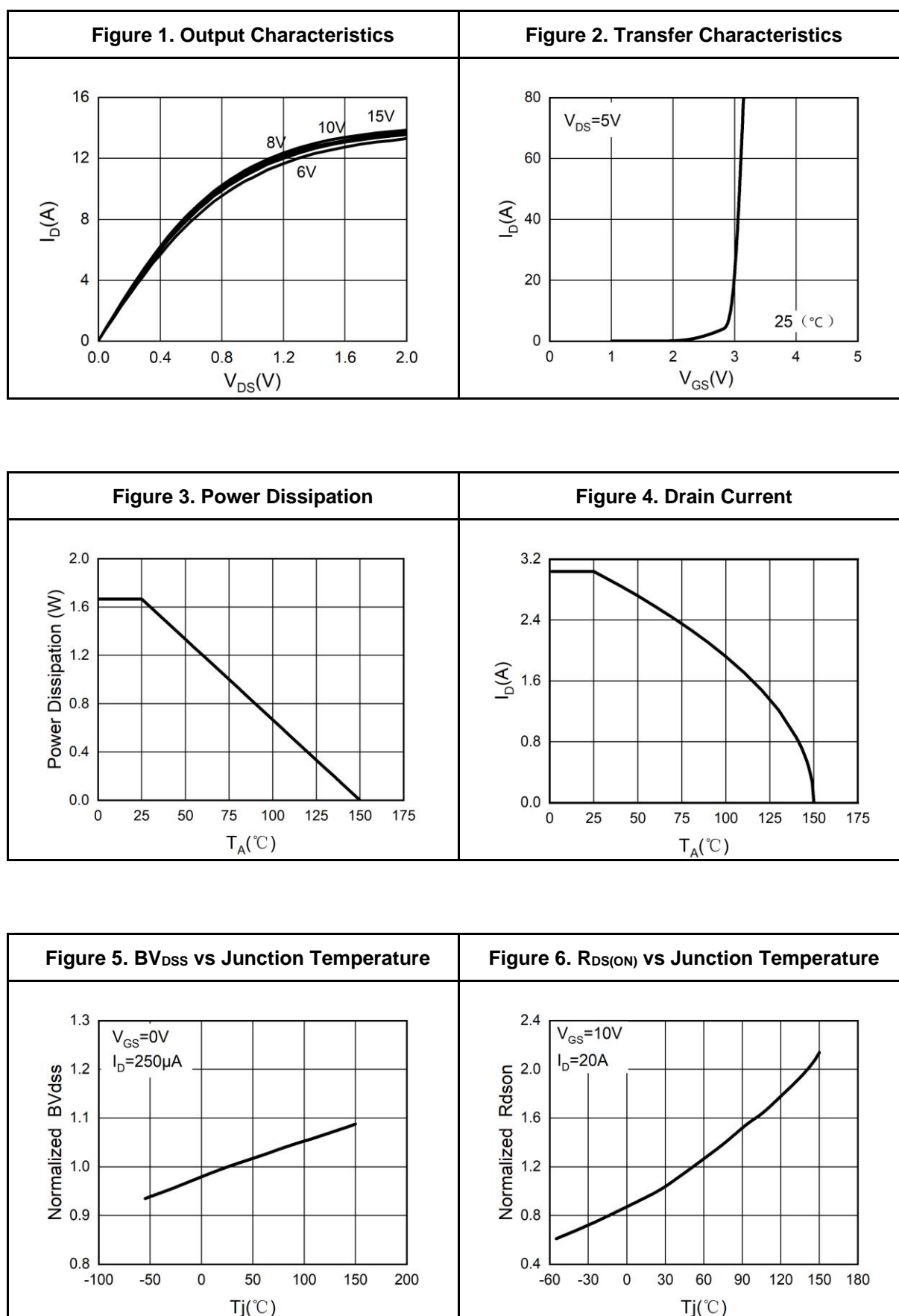
Notes 2.EAS condition: $T_J=25^{\circ}\text{C}, V_{DD}=40V, V_G=10V, R_g=25\Omega, L=0.5\text{mH}$.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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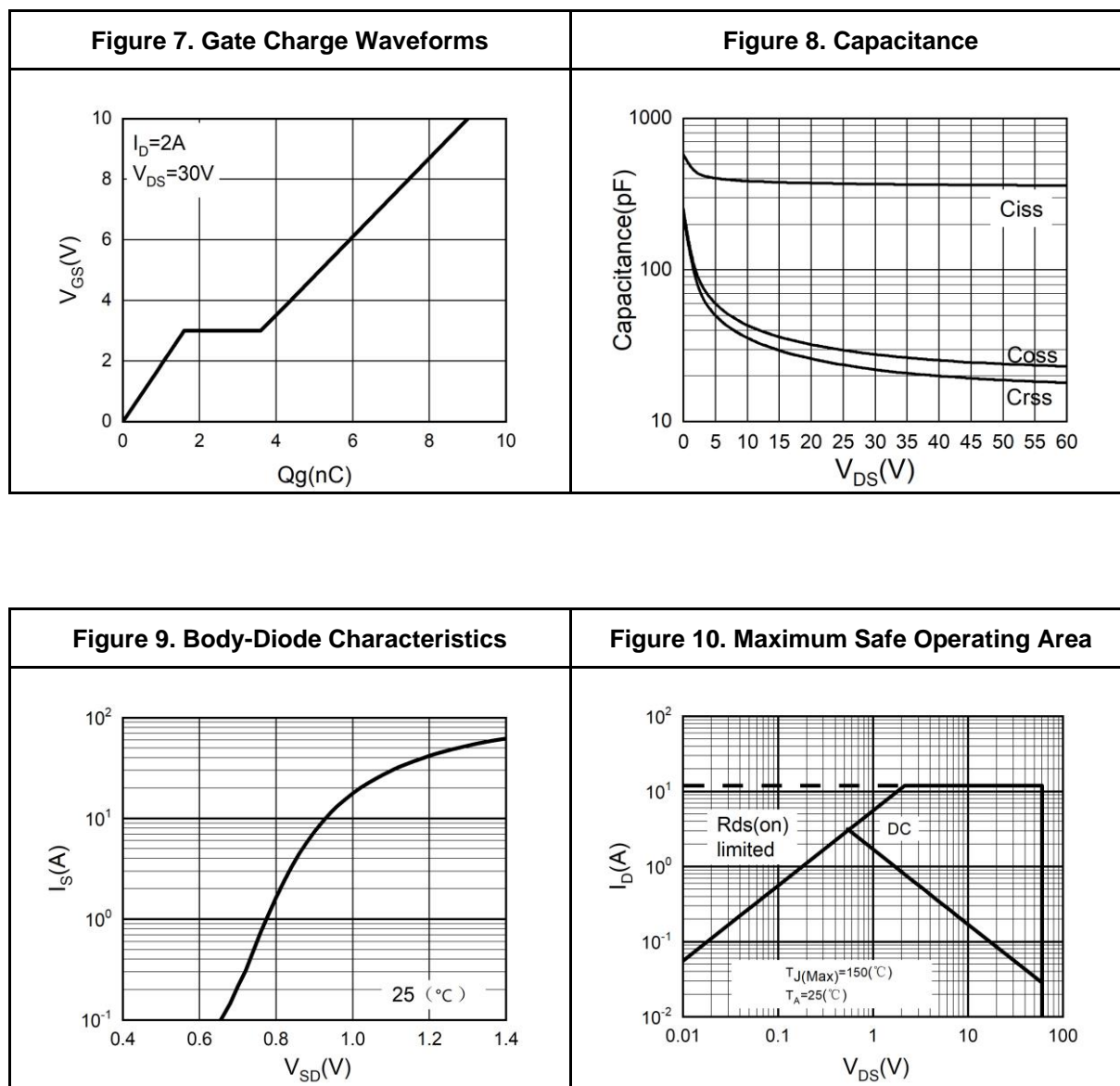
Typical Electrical And Thermal Characteristics (Curves)





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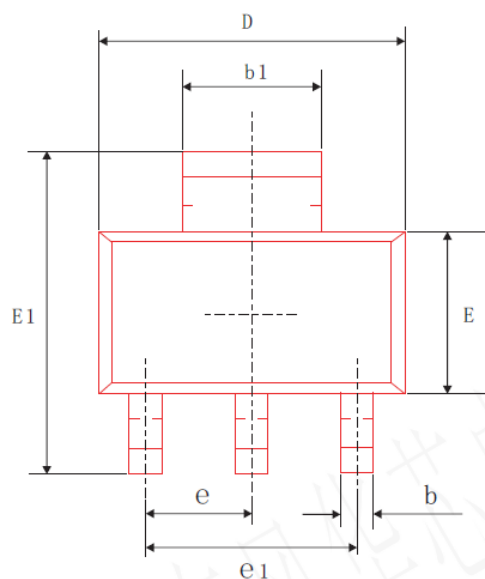
Typical Electrical And Thermal Characteristics (Curves)



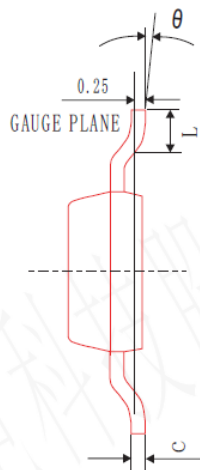


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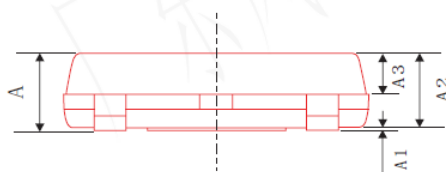
SOT-223-3L Package Information



TOP VIEW



SIDE VIEW



SIDE VIEW

COMMON DIMENSIONS
(UNITS OF MEASURE=mm)

SYMBOL	MIN	NOM	MAX
A	---	---	1.80
A1	0.00	0.05	0.10
A2	1.50	1.60	1.70
A3	0.85	0.90	0.95
b	0.66	0.70	0.80
b1	2.96	3.00	3.10
c	0.25	0.30	0.35
D	6.30	6.50	6.70
E	3.30	3.50	3.70
E1	6.80	7.00	7.20
e1	4.40	4.60	4.80
L	0.90	---	1.15
θ	0°	5°	10°
e	2.3 BSC		



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